

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4619582

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HO CHEUNG SHUM	04/27/2015
YANG SONG	04/27/2015
RECEIVING PARTY DATA	
Name:	THE UNIVERSITY OF HONG KONG
Street Address:	POKFULAM ROAD
City:	HONG KONG
State/Country:	HONG KONG
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15720246
CORRESPONDENCE DATA	
Fax Number: <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	404-879-2151
Email:	cindy@pabstpatent.com
Correspondent Name:	PABST PATENT GROUP LLP
Address Line 1:	1545 PEACHTREE STREET NE
Address Line 2:	SUITE 320
Address Line 4:	ATLANTA, GEORGIA 30309
ATTORNEY DOCKET NUMBER:	UHK 00486 DIV
NAME OF SUBMITTER:	CINDY PHILLIPS
SIGNATURE:	/Cindy Phillips/
DATE SIGNED:	09/29/2017
Total Attachments: 2 source=UHK_00486_Executed_Assignment_Inventors_UHK#page1.tif source=UHK_00486_Executed_Assignment_Inventors_UHK#page2.tif	

ASSIGNMENT

WHEREAS, I, **SHUM Ho Cheung**, a citizen of Hong Kong, residing at Flat E, 15th Floor, Tower 2, 8 Waterloo Road, Yau Ma Tei, Kowloon, Hong Kong

I, **SONG Yang**, a citizen of China, residing at Block D, Room 5H, Pokfield Road Residence, No. 13-21 Pokfield Road, Pok Fu Lam, Hong Kong

(Hereinafter "ASSIGNOR") are the inventors of the invention in

Core-Shell Capsules for Encapsulation of Particles, Colloids, and Cells
for which we have executed an application for a Patent of the United States

which is identified by PABST PATENT GROUP LLP docket no. UHK00486
which was filed on **9 December 2014**, Application No. 14/564,372.

and WHEREAS, The University of Hong Kong, ASSIGNEE, located at Pokfulam Road, HONG KONG is desirous of obtaining our entire right, title and interest in, to and under the said invention and the said application:

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, has sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, our entire right, title and interest (including without limitation all rights to sue for past, present and future infringement, to collect royalties and all causes of action and enforcement rights, whether known or unknown, currently pending or otherwise, including the right to pursue damages, injunctive relief and other infringement remedies) in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewal and reissues thereof;

AND WE HEREBY authorize and request the Commissioner of Patents, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.


AND WE HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testifying in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, we hereunto set our hands and seals the day and year set opposite our respective signatures.


Date April 27, 2015

Witness:



SHUM Ho Cheung L.S.

MA QINGMING
Printed Name



Signature of Witness


Date April 27, 2015

Witness:



SONG Yang L.S.

MA QINGMING
Printed Name



Signature of Witness